Engr354: Digital Logic Circuits

Chapter 3: Implementation Technology

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Chapter 3 Overview

In this chapter you will learn about:

- How transistors are used as switches;
- Integrated circuit technology;
- Complementary Metal-Oxide-Semiconductor (MOS) logic gates;
- Programmable Logic Devices.





























































Custom Chips

- Created from scratch;
- Designer selects number, placement, and connections for each and every transistor;
- Most dense and highest speed;
- Requires a substantial design effort;
- Used only when high performance and density (and maybe secrecy) is required
 - Like processors or memories.



- Gates prebuilt and stored in a library;
- Gates needed for a design are selected and placed via synthesis algorithms, and wires are routed between them;
- Standard-cell chips are often called *application specific integrated circuits* (ASIC's);
- CAD tools exist to place and route gates.

Gate-Arrays Parts of chip are prefabricated (transistors); Parts of chip are custom fabricated (wires); Provides cost savings since all template wafers are identical; Many variants exist.





